06-04-1998



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U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office Docket No.: 98 P 7520 US

100728286

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. Name of conveying party(ies): Name and address of receiving party(ies) Hua SHEN Name: Siemens Microelectronics, Inc. Joachim HOEPFNER Internal Address: Additional name(s) of conveying party(ies) attached? ____ Yes __X _ No 3. Nature of conveyance: Street Address: 10950 North Tantau Avenue X Assignment Merger Security Agreement Change of Name City: Cupertino State: CA ZIP: 95014 ___ Other ___ Additional name(s) & address(es) attached? Yes X No Execution Date: May 4, 1998 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: May 8, 1998 B. Patent No.(s) A. Patent Application No.(s) To be assigned Additional numbers attached? Yes X No 6. Total number of applications and patents involved: __1_ 5. Name and address of party to whom correspondence concerning document should be mailed: 7. Total Fee (37 CFR 3.41)\$ 40.00 Name: Elsa Keller Internal Address:___ Enclosed X Authorized to be charged to deposit account Siemens Corporation Intellectual Property Department 8. Deposit Account No. Street Address: 186 Wood Avenue South 19-2179 City: Iselin State: NJ ZIP: 08830 DO NOT USE THIS SPACE 9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attacked popy is a true copy of the original document. Youald B. Prochburg Signature May 8, 1998 Donald B. Paschburg Reg. No. 33,753 Date Name of Person Signing Total number of pages including cover sheet, attachments, and document:

ASSIGNMENT

For good and valuable consideration, We, Hua Shen, residing at 1C Hudson View Dr. Beacon, New York 12508 a citizen of China; and Joachim Hoepfner, residing at 5 Hollow Lane, Poughkeepsie, New York 12603, a citizen of Germany.

Hereby sell, assign, and transfer to Siemens Microelectronics, Inc., a corporation organized and existing under the laws of the state of Delaware, having its principal place of business at 10950 North Tantau Ave., Cupertino, CA 95014,

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

STACK CAPACITOR WITH IMPROVED PLUG CONDUCTIVITY

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this the undersigned will execute agreement, all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its representatives shall consider successors, assigns, or desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

> PATENT REEL: 9201 FRAME: 0797

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date:	514198	the!
		Hua Shen
	Brian Lee (type name)	
Witness:	(type name)	
Date:	5/4/98	Joachim Hoepfner
Witness:	Brian Lee (type name)	
Witness:	(type name)	